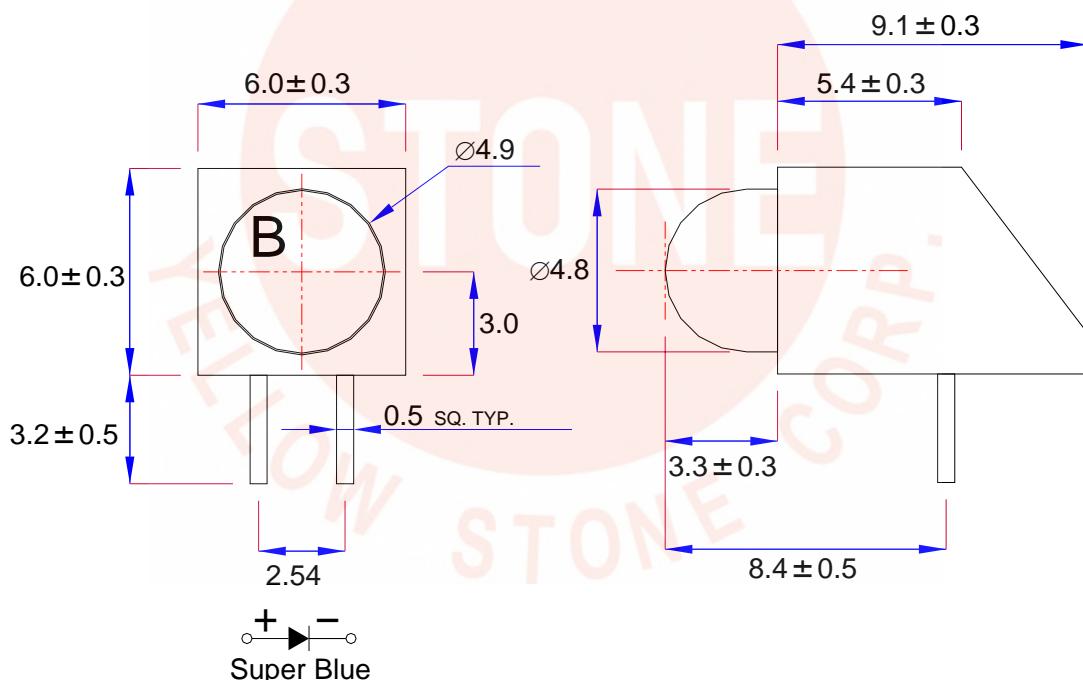


● Features:

1. Emitted color : Super Blue (BL-BB51V3N)
2. Lens Appearance : Blue Diffused
3. Low power consumption.
4. High efficiency.
5. Versatile mounting on P.C. Board or panel.
6. Low current requirement.
7. 4.8mm diameter package.
8. This product don't contained restriction substance, compliance ROHS standard.

● Package dimensions:



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25 mm (0.01") unless otherwise specified.
3. Lead spacing is measured where the leads emerge from the package.
4. Specifications are subject to change without notice.

● Absolute maximum ratings(Ta=25°C)

| Parameter | Symbol | Rating | Unit |
|------------------------------------|------------------|-----------------------|------|
| Power Dissipation | Pd | 120 | mW |
| Forward Current | I _F | 30 | mA |
| Peak Forward Current ^{*1} | I _{FP} | 150 | mA |
| Reverse Voltage | V _R | 5 | V |
| Electrostatic Discharge | ESD | 150 | V |
| Operating Temperature | T _{opr} | -40°C ~ 85°C | |
| Storage Temperature | T _{stg} | -40°C ~ 100°C | |
| Soldering Temperature | T _{sol} | 260°C (for 5 seconds) | |
| Hand Soldering Temperature | T _{sol} | 350°C (for 3 seconds) | |

*¹Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width.

● Electrical and optical characteristics(Ta=25°C)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
|--------------------------|-------------------|----------------------|------|------|------|------|
| Forward Voltage | V _F | I _F =20mA | - | 3.2 | 3.6 | V |
| Luminous Intensity | I _v | I _F =20mA | - | 660 | - | mcd |
| Reverse Current | I _R | V _R =5V | - | - | 100 | μA |
| Peak Wave Length | λ p | I _F =20mA | - | 470 | - | nm |
| Dominant Wave Length | λ d | I _F =20mA | 460 | - | 475 | nm |
| Spectral Line Half-width | Δ λ | I _F =20mA | - | 30 | - | nm |
| Viewing Angle | 2θ _{1/2} | I _F =20mA | - | 40 | - | deg |

● Typical electro-optical characteristics curves

Fig.1 Relative intensity vs. Wavelength

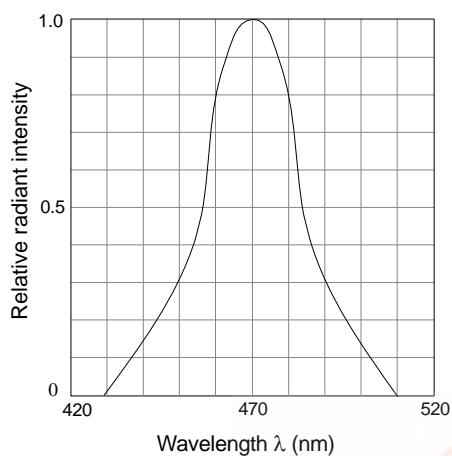


Fig.2 Forward current derating curve vs. Ambient temperature

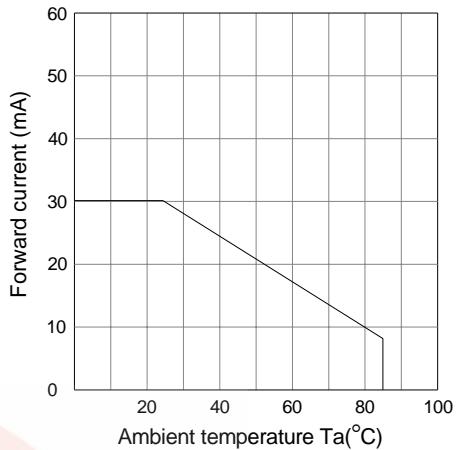


Fig.3 Forward current vs. Forward voltage

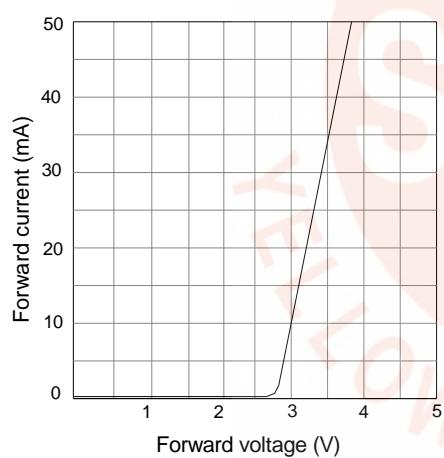


Fig.4 Relative luminous intensity vs. Ambient temperature

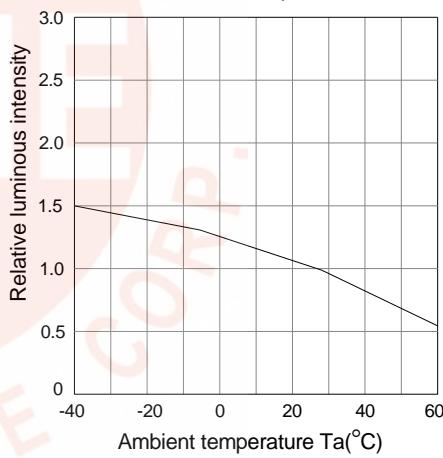


Fig.5 Relative luminous intensity vs. Forward current

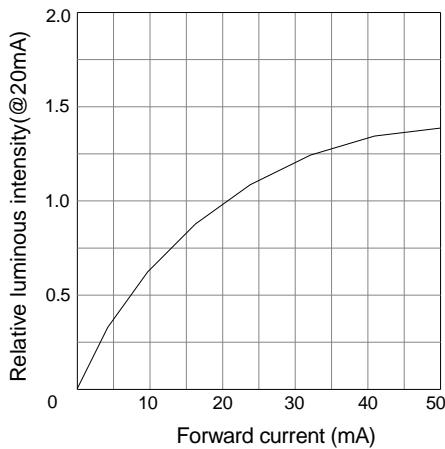
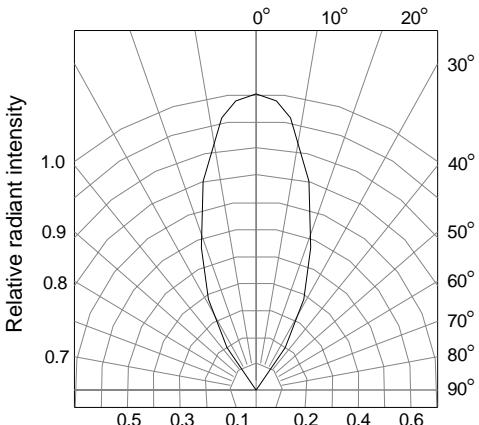
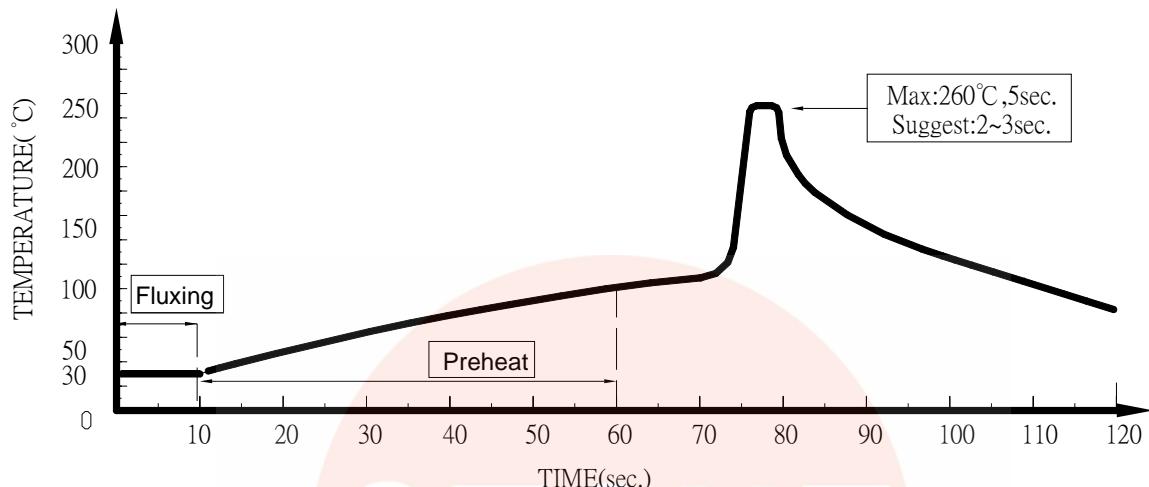


Fig.6 Radiation diagram



● Dip Soldering



1. Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature, especially during soldering
2. DIP soldering and hand soldering should not be done more than one time.
3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temperature.
4. Avoid rapid cooling during temperature ramp-down process
5. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

● IRON Soldering

A : Max : 350°C Within 3 sec. One time only.

B : For 3mm LED without flange, if the LED epoxy lays flat on the PCB, the welding condition is 350°C within 2 seconds, one time only.

